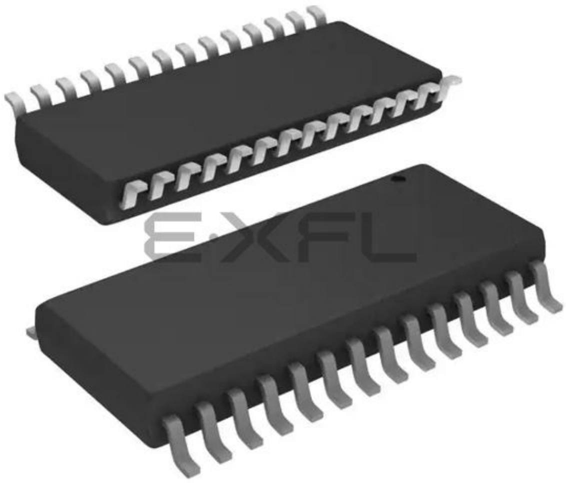


What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 19x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f25k22-e-so

3.0 POWER-MANAGED MODES

PIC18(L)F2X/4XK22 devices offer a total of seven operating modes for more efficient power management. These modes provide a variety of options for selective power conservation in applications where resources may be limited (i.e., battery-powered devices).

There are three categories of power-managed modes:

- Run modes
- Idle modes
- Sleep mode

These categories define which portions of the device are clocked and sometimes, what speed. The Run and Idle modes may use any of the three available clock sources (primary, secondary or internal oscillator block). The Sleep mode does not use a clock source.

The power-managed modes include several power-saving features offered on previous PIC® microcontroller devices. One of the clock switching features allows the controller to use the secondary oscillator (SOSC) in place of the primary oscillator. Also included is the Sleep mode, offered by all PIC microcontroller devices, where all device clocks are stopped.

3.1 Selecting Power-Managed Modes

Selecting a power-managed mode requires two decisions:

- Whether or not the CPU is to be clocked
- The selection of a clock source

The IDLEN bit (OSCCON<7>) controls CPU clocking, while the SCS<1:0> bits (OSCCON<1:0>) select the clock source. The individual modes, bit settings, clock sources and affected modules are summarized in Table 3-1.

3.1.1 CLOCK SOURCES

The SCS<1:0> bits allow the selection of one of three clock sources for power-managed modes. They are:

- the primary clock, as defined by the FOSC<3:0> Configuration bits
- the secondary clock (the SOSC oscillator)
- the internal oscillator block

3.1.2 ENTERING POWER-MANAGED MODES

Switching from one power-managed mode to another begins by loading the OSCCON register. The SCS<1:0> bits select the clock source and determine which Run or Idle mode is to be used. Changing these bits causes an immediate switch to the new clock source, assuming that it is running. The switch may also be subject to clock transition delays. Refer to **Section 2.11 “Clock Switching”** for more information.

Entry to the power-managed Idle or Sleep modes is triggered by the execution of a `SLEEP` instruction. The actual mode that results depends on the status of the IDLEN bit.

Depending on the current mode and the mode being switched to, a change to a power-managed mode does not always require setting all of these bits. Many transitions may be done by changing the oscillator select bits, or changing the IDLEN bit, prior to issuing a `SLEEP` instruction. If the IDLEN bit is already configured correctly, it may only be necessary to perform a `SLEEP` instruction to switch to the desired mode.

TABLE 3-1: POWER-MANAGED MODES

Mode	OSCCON Bits		Module Clocking		Available Clock and Oscillator Source
	IDLEN(1)	SCS<1:0>	CPU	Peripherals	
Sleep	0	N/A	Off	Off	None – All clocks are disabled
PRI_RUN	N/A	00	Clocked	Clocked	Primary – LP, XT, HS, RC, EC and Internal Oscillator Block(2). This is the normal full-power execution mode.
SEC_RUN	N/A	01	Clocked	Clocked	Secondary – SOSC Oscillator
RC_RUN	N/A	1x	Clocked	Clocked	Internal Oscillator Block(2)
PRI_IDLE	1	00	Off	Clocked	Primary – LP, XT, HS, HSPLL, RC, EC
SEC_IDLE	1	01	Off	Clocked	Secondary – SOSC Oscillator
RC_IDLE	1	1x	Off	Clocked	Internal Oscillator Block(2)

Note 1: IDLEN reflects its value when the `SLEEP` instruction is executed.

2: Includes HFINTOSC and HFINTOSC postscaler, as well as the LFINTOSC source.

4.0 RESET

The PIC18(L)F2X/4XK22 devices differentiate between various kinds of Reset:

a) Power-on Reset (POR)
b) $\overline{\text{MCLR}}$ Reset during normal operation
c) $\overline{\text{MCLR}}$ Reset during power-managed modes
d) Watchdog Timer (WDT) Reset (during execution)
e) Programmable Brown-out Reset (BOR)
f) RESET Instruction
g) Stack Full Reset
h) Stack Underflow Reset

This section discusses Resets generated by $\overline{\text{MCLR}}$, POR and BOR and covers the operation of the various start-up timers. Stack Reset events are covered in **Section 5.2.0.1 “Stack Full and Underflow Resets”**. WDT Resets are covered in **Section 24.3 “Watchdog Timer (WDT)”**.

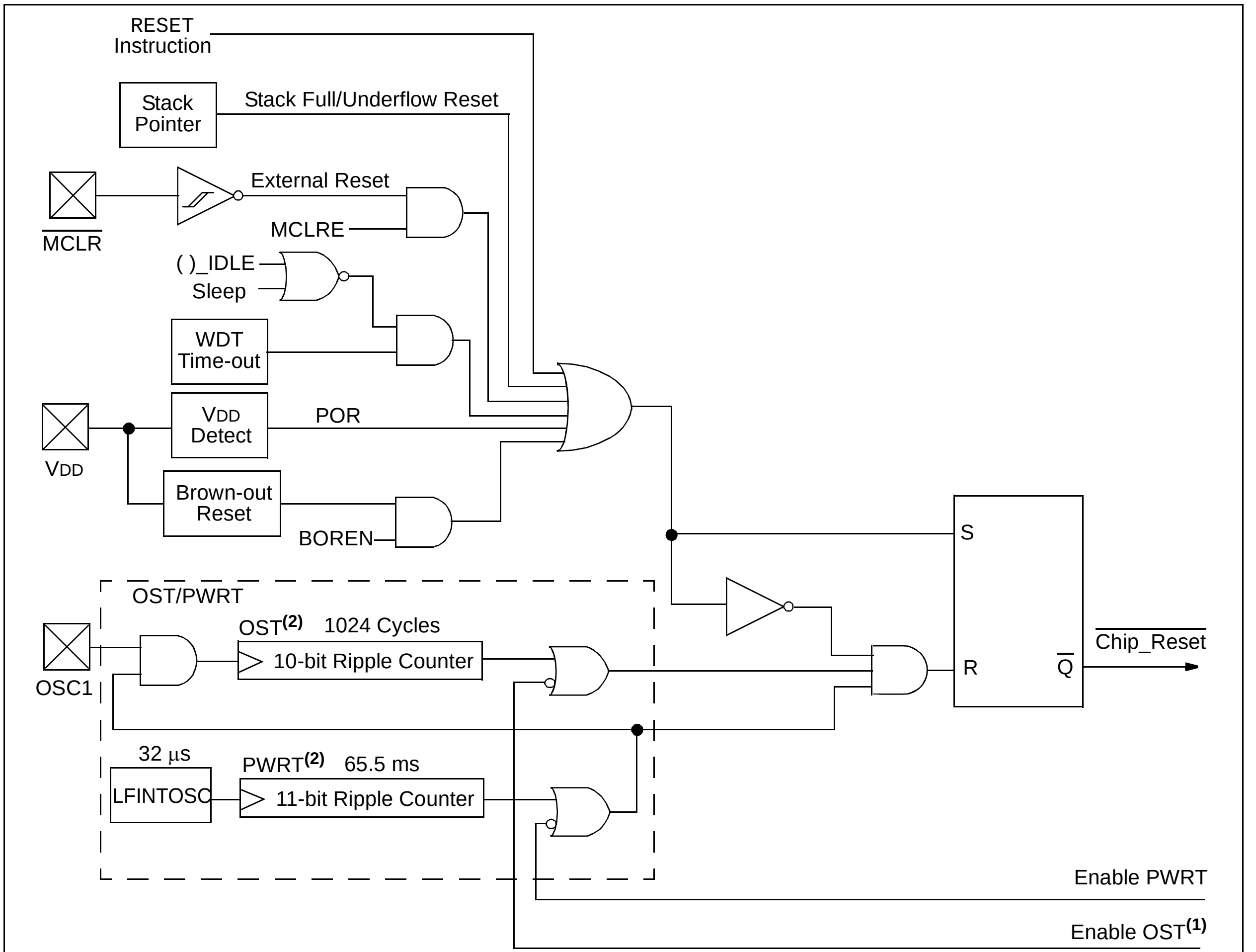
A simplified block diagram of the On-Chip Reset Circuit is shown in Figure 4-1.

4.1 RCON Register

Device Reset events are tracked through the RCON register (Register 4-1). The lower five bits of the register indicate that a specific Reset event has occurred. In most cases, these bits can only be cleared by the event and must be set by the application after the event. The state of these flag bits, taken together, can be read to indicate the type of Reset that just occurred. This is described in more detail in **Section 4.7 “Reset State of Registers”**.

The RCON register also has control bits for setting interrupt priority (IPEN) and software control of the BOR (SBOREN). Interrupt priority is discussed in **Section 9.0 “Interrupts”**. BOR is covered in **Section 4.5 “Brown-out Reset (BOR)”**.

FIGURE 4-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



Note 1: See Table 4-2 for time-out situations.

2: PWRT and OST counters are reset by POR and BOR. See Sections 4.4 and 4.5.

The Stack Pointer is readable and writable and the address on the top of the stack is readable and writable through the Top-of-Stack (TOS) Special File Registers. Data can also be pushed to, or popped from the stack, using these registers.

A `CALL` type instruction causes a push onto the stack; the Stack Pointer is first incremented and the location pointed to by the Stack Pointer is written with the contents of the PC (already pointing to the instruction following the `CALL`). A `RETURN` type instruction causes a pop from the stack; the contents of the location pointed to by the STKPTR are transferred to the PC and then the Stack Pointer is decremented.

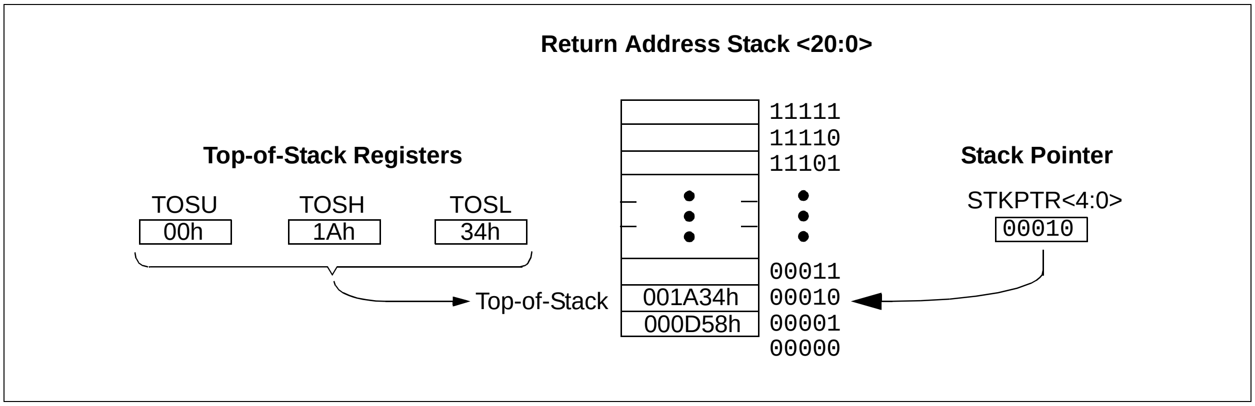
The Stack Pointer is initialized to '`00000`' after all Resets. There is no RAM associated with the location corresponding to a Stack Pointer value of '`00000`'; this is only a Reset value. Status bits indicate if the stack is full or has overflowed or has underflowed.

5.1.2.1 Top-of-Stack Access

Only the top of the return address stack (TOS) is readable and writable. A set of three registers, TOSU:TOSH:TOSL, hold the contents of the stack location pointed to by the STKPTR register (Figure 5-2). This allows users to implement a software stack if necessary. After a `CALL`, `RCALL` or interrupt, the software can read the pushed value by reading the TOSU:TOSH:TOSL registers. These values can be placed on a user defined software stack. At return time, the software can return these values to TOSU:TOSH:TOSL and do a return.

The user must disable the Global Interrupt Enable (GIE) bits while accessing the stack to prevent inadvertent stack corruption.

FIGURE 5-2: RETURN ADDRESS STACK AND ASSOCIATED REGISTERS



5.1.2.2 Return Stack Pointer (STKPTR)

The STKPTR register (Register 5-1) contains the Stack Pointer value, the STKFUL (stack full) Status bit and the STKUNF (Stack Underflow) Status bits. The value of the Stack Pointer can be 0 through 31. The Stack Pointer increments before values are pushed onto the stack and decrements after values are popped off the stack. On Reset, the Stack Pointer value will be zero. The user may read and write the Stack Pointer value. This feature can be used by a Real-Time Operating System (RTOS) for return stack maintenance.

After the PC is pushed onto the stack 31 times (without popping any values off the stack), the STKFUL bit is set. The STKFUL bit is cleared by software or by a POR.

The action that takes place when the stack becomes full depends on the state of the STVREN (Stack Overflow Reset Enable) Configuration bit. (Refer to **Section 24.1 "Configuration Bits"** for a description of the device Configuration bits.) If STVREN is set (default), the 31st push will push the (PC + 2) value onto the stack, set the STKFUL bit and reset the device. The STKFUL bit will remain set and the Stack Pointer will be set to zero.

If STVREN is cleared, the STKFUL bit will be set on the 31st push and the Stack Pointer will increment to 31. Any additional pushes will not overwrite the 31st push and STKPTR will remain at 31.

When the stack has been popped enough times to unload the stack, the next pop will return a value of zero to the PC and sets the STKUNF bit, while the Stack Pointer remains at zero. The STKUNF bit will remain set until cleared by software or until a POR occurs.

Note:	Returning a value of zero to the PC on an underflow has the effect of vectoring the program to the Reset vector, where the stack conditions can be verified and appropriate actions can be taken. This is not the same as a Reset, as the contents of the SFRs are not affected.

TABLE 5-2: REGISTER FILE SUMMARY FOR PIC18(L)F2X/4XK22 DEVICES (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
FD1h	WDTCON	—	—	—	—	—	—	—	SWDTEN	---- ---0
FD0h	RCON	IPEN	SBOREN	—	$\overline{RI}$	$\overline{TO}$	$\overline{PD}$	$\overline{POR}$	$\overline{BOR}$	01-1 1100
FCFh	TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register								xxxx xxxx
FCEh	TMR1L	Least Significant Byte of the 16-bit TMR1 Register								xxxx xxxx
FCDh	T1CON	TMR1CS<1:0>		T1CKPS<1:0>		T1SOSCEN	$\overline{T1SYNC}$	T1RD16	TMR1ON	0000 0000
FCCh	T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/$\overline{DONE}$	T1GVAL	T1GSS<1:0>		0000 xx00
FCBh	SSP1CON3	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	0000 0000
FCAh	SSP1MSK	SSP1 MASK Register bits								1111 1111
FC9h	SSP1BUF	SSP1 Receive Buffer/Transmit Register								xxxx xxxx
FC8h	SSP1ADD	SSP1 Address Register in I^2C Slave Mode. SSP1 Baud Rate Reload Register in I^2C Master Mode								0000 0000
FC7h	SSP1STAT	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	0000 0000
FC6h	SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM<3:0>				0000 0000
FC5h	SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000
FC4h	ADRESH	A/D Result, High Byte								xxxx xxxx
FC3h	ADRESL	A/D Result, Low Byte								xxxx xxxx
FC2h	ADCON0	—	CHS<4:0>					GO/$\overline{DONE}$	ADON	--00 0000
FC1h	ADCON1	TRIGSEL	—	—	—	PVCFG<1:0>		NVCFG<1:0>		0--- 0000
FC0h	ADCON2	ADFM	—	ACQT<2:0>			ADCS<2:0>			0-00 0000
FBFh	CCPR1H	Capture/Compare/PWM Register 1, High Byte								xxxx xxxx
FBEh	CCPR1L	Capture/Compare/PWM Register 1, Low Byte								xxxx xxxx
FBDh	CCP1CON	P1M<1:0>		DC1B<1:0>		CCP1M<3:0>				0000 0000
FBCh	TMR2	Timer2 Register								0000 0000
FBBh	PR2	Timer2 Period Register								1111 1111
FBAh	T2CON	—	T2OUTPS<3:0>				TMR2ON	T2CKPS<1:0>		-000 0000
FB9h	PSTR1CON	—	—	—	STR1SYNC	STR1D	STR1C	STR1B	STR1A	---0 0001
FB8h	BAUDCON1	ABDOVF	RCIDL	DTRXP	CKTXP	BRG16	—	WUE	ABDEN	0100 0-00
FB7h	PWM1CON	P1RSEN	P1DC<6:0>							0000 0000
FB6h	ECCP1AS	CCP1ASE	CCP1AS<2:0>			PSS1AC<1:0>		PSS1BD<1:0>		0000 0000
FB4h	T3GCON	TMR3GE	T3GPOL	T3GTM	T3GSPM	T3GGO/$\overline{DONE}$	T3GVAL	T3GSS<1:0>		0000 0x00
FB3h	TMR3H	Holding Register for the Most Significant Byte of the 16-bit TMR3 Register								xxxx xxxx
FB2h	TMR3L	Least Significant Byte of the 16-bit TMR3 Register								xxxx xxxx
FB1h	T3CON	TMR3CS<1:0>		T3CKPS<1:0>		T3SOSCEN	$\overline{T3SYNC}$	T3RD16	TMR3ON	0000 0000
FB0h	SPBRGH1	EUSART1 Baud Rate Generator, High Byte								0000 0000
FAFh	SPBRG1	EUSART1 Baud Rate Generator, Low Byte								0000 0000
FAEh	RCREG1	EUSART1 Receive Register								0000 0000
FADh	TXREG1	EUSART1 Transmit Register								0000 0000
FACh	TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010
FABh	RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x
FAAh	EEADRH(5)	—	—	—	—	—	—	EEADR<9:8>		---- --00
FA9h	EEADR	EEADR<7:0>								0000 0000
FA8h	EEDATA	EEPROM Data Register								0000 0000
FA7h	EECON2	EEPROM Control Register 2 (not a physical register)								---- --00
FA6h	EECON1	EEPGD	CFGS	—	FREE	WRERR	WREN	WR	RD	xx-0 x000
FA5h	IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	CTMUIP	TMR5GIP	TMR3GIP	TMR1GIP	0000 0000
FA4h	PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	CTMUIF	TMR5GIF	TMR3GIF	TMR1GIF	0000 0000
FA3h	PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	CTMUIE	TMR5GIE	TMR3GIE	TMR1GIE	0000 0000

Legend: x = unknown, u = unchanged, — = unimplemented, q = value depends on condition

Note 1: PIC18(L)F4XK22 devices only.

2: PIC18(L)F2XK22 devices only.

3: PIC18(L)F23/24K22 and PIC18(L)F43/44K22 devices only.

4: PIC18(L)F26K22 and PIC18(L)F46K22 devices only.

REGISTER 9-8: PIR5: PERIPHERAL INTERRUPT (FLAG) REGISTER 5

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	TMR6IF	TMR5IF	TMR4IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-3 **Unimplemented:** Read as ‘0’

bit 2 **TMR6IF:** TMR6 to PR6 Match Interrupt Flag bit
1 = TMR6 to PR6 match occurred (must be cleared in software)
0 = No TMR6 to PR6 match occurred

bit 1 **TMR5IF:** TMR5 Overflow Interrupt Flag bit
1 = TMR5 register overflowed (must be cleared in software)
0 = TMR5 register did not overflow

bit 0 **TMR4IF:** TMR4 to PR4 Match Interrupt Flag bit
1 = TMR4 to PR4 match occurred (must be cleared in software)
0 = No TMR4 to PR4 match occurred

REGISTER 9-9: PIE1: PERIPHERAL INTERRUPT ENABLE (FLAG) REGISTER 1

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as ‘0’.

bit 6 **ADIE:** A/D Converter Interrupt Enable bit
1 = Enables the A/D interrupt
0 = Disables the A/D interrupt

bit 5 **RC1IE:** EUSART1 Receive Interrupt Enable bit
1 = Enables the EUSART1 receive interrupt
0 = Disables the EUSART1 receive interrupt

bit 4 **TX1IE:** EUSART1 Transmit Interrupt Enable bit
1 = Enables the EUSART1 transmit interrupt
0 = Disables the EUSART1 transmit interrupt

bit 3 **SSP1IE:** Master Synchronous Serial Port 1 Interrupt Enable bit
1 = Enables the MSSP1 interrupt
0 = Disables the MSSP1 interrupt

bit 2 **CCP1IE:** CCP1 Interrupt Enable bit
1 = Enables the CCP1 interrupt
0 = Disables the CCP1 interrupt

bit 1 **TMR2IE:** TMR2 to PR2 Match Interrupt Enable bit
1 = Enables the TMR2 to PR2 match interrupt
0 = Disables the TMR2 to PR2 match interrupt

bit 0 **TMR1IE:** TMR1 Overflow Interrupt Enable bit
1 = Enables the TMR1 overflow interrupt
0 = Disables the TMR1 overflow interrupt

10.6 PORTE Registers

Depending on the particular PIC18(L)F2X/4XK22 device selected, PORTE is implemented in two different ways.

10.6.1 PORTE ON 40/44-PIN DEVICES

For PIC18(L)F2X/4XK22 devices, PORTE is a 4-bit wide port. Three pins (RE0/P3A/CCP3/AN5, RE1/P3B/AN6 and RE2/CCP5/AN7) are individually configurable as inputs or outputs. These pins have Schmitt Trigger input buffers. When selected as an analog input, these pins will read as '0's.

The corresponding data direction register is TRISE. Setting a TRISE bit (= 1) will make the corresponding PORTE pin an input (i.e., disable the output driver). Clearing a TRISE bit (= 0) will make the corresponding PORTE pin an output (i.e., enable the output driver and put the contents of the output latch on the selected pin).

TRISE controls the direction of the REx pins, even when they are being used as analog inputs. The user must make sure to keep the pins configured as inputs when using them as analog inputs.

The Data Latch register (LATE) is also memory mapped. Read-modify-write operations on the LATE register read and write the latched output value for PORTE.

> **Note:** On a Power-on Reset, RE<2:0> are configured as analog inputs.

The fourth pin of PORTE ($\overline{\text{MCLR}}$/VPP/RE3) is an input only pin. Its operation is controlled by the MCLRE Configuration bit. When selected as a port pin (MCLRE = 0), it functions as a digital input only pin; as such, it does not have TRIS or LAT bits associated with its operation. Otherwise, it functions as the device's Master Clear input. In either configuration, RE3 also functions as the programming voltage input during programming.

> **Note:** On a Power-on Reset, RE3 is enabled as a digital input only if Master Clear functionality is disabled.

EXAMPLE 10-5: INITIALIZING PORTE

```
CLRF    PORTE   ; Initialize PORTE by
                ; clearing output
                ; data latches
CLRF    LATE    ; Alternate method
                ; to clear output
                ; data latches
CLRF    ANSELE  ; Configure analog pins
                ; for digital only
MOVLW   05h     ; Value used to
                ; initialize data
                ; direction
MOVWF   TRISE   ; Set RE<0> as input
                ; RE<1> as output
                ; RE<2> as input
```

10.6.2 PORTE ON 28-PIN DEVICES

For PIC18F2XK22 devices, PORTE is only available when Master Clear functionality is disabled (MCLR = 0). In these cases, PORTE is a single bit, input only port comprised of RE3 only. The pin operates as previously described.

10.6.3 RE3 WEAK PULL-UP

The port RE3 pin has an individually controlled weak internal pull-up. When set, the WPUE3 (TRISE<7>) bit enables the RE3 pin pull-up. The $\overline{\text{RBPU}}$ bit of the INTCON2 register controls pull-ups on both PORTB and PORTE. When $\overline{\text{RBPU}}$ = 0, the weak pull-ups become active on all pins which have the WPUE3 or WPUBx bits set. When set, the RBPU bit disables all weak pull-ups. The pull-ups are disabled on a Power-on Reset. When the RE3 port pin is configured as $\overline{\text{MCLR}}$, (CONFIG3H<7>, MCLRE=1 and CONFIG4L<2>, LVP=0), or configured for Low Voltage Programming, (MCLRE=x and LVP=1), the pull-up is always enabled and the WPUE3 bit has no effect.

10.6.4 PORTE OUTPUT PRIORITY

Each PORTE pin is multiplexed with other functions. The pins, their combined functions and their output priorities are briefly described here. For additional information, refer to the appropriate section in this data sheet.

When multiple outputs are enabled, the actual pin control goes to the peripheral with the higher priority. Table 10-4 lists the PORTE pin functions from the highest to the lowest priority.

Analog input functions, such as ADC, comparator and SR latch inputs, are not shown in the priority lists.

These inputs are active when the I/O pin is set for Analog mode using the ANSELx registers. Digital output functions may control the pin when it is in Analog mode with the priority shown below.

15.5.2 SLAVE RECEPTION

When the R/$\overline{\text{W}}$ bit of a matching received address byte is clear, the R/$\overline{\text{W}}$ bit of the SSPxSTAT register is cleared. The received address is loaded into the SSPxBUF register and acknowledged.

When the overflow condition exists for a received address, then not Acknowledge is given. An overflow condition is defined as either bit BF of the SSPxSTAT register is set, or bit SSPxOV of the SSPxCON1 register is set. The BOEN bit of the SSPxCON3 register modifies this operation. For more information see Register 15-5.

An MSSPx interrupt is generated for each transferred data byte. Flag bit, SSPxIF, must be cleared by software.

When the SEN bit of the SSPxCON2 register is set, SCLx will be held low (clock stretch) following each received byte. The clock must be released by setting the CKP bit of the SSPxCON1 register, except sometimes in 10-bit mode. See **Section 15.2.3 “SPI Master Mode”** for more detail.

15.5.2.1 7-bit Addressing Reception

This section describes a standard sequence of events for the MSSPx module configured as an I^{2}C slave in 7-bit Addressing mode. All decisions made by hardware or software and their effect on reception. Figure 15-14 and Figure 15-5 are used as a visual reference for this description.

This is a step by step process of what typically must be done to accomplish I^{2}C communication.

1. Start bit detected.
2. S bit of SSPxSTAT is set; SSPxIF is set if interrupt on Start detect is enabled.
3. Matching address with R/$\overline{\text{W}}$ bit clear is received.
4. The slave pulls SDAx low sending an $\overline{\text{ACK}}$ to the master, and sets SSPxIF bit.
5. Software clears the SSPxIF bit.
6. Software reads received address from SSPxBUF clearing the BF flag.
7. If SEN = 1; Slave software sets CKP bit to release the SCLx line.
8. The master clocks out a data byte.
9. Slave drives SDAx low sending an $\overline{\text{ACK}}$ to the master, and sets SSPxIF bit.
10. Software clears SSPxIF.
11. Software reads the received byte from SSPxBUF clearing BF.
12. Steps 8-12 are repeated for all received bytes from the master.
13. Master sends Stop condition, setting P bit of SSPxSTAT, and the bus goes Idle.

15.5.2.2 7-bit Reception with AHEN and DHEN

Slave device reception with AHEN and DHEN set operate the same as without these options with extra interrupts and clock stretching added after the 8th falling edge of SCLx. These additional interrupts allow the slave software to decide whether it wants to $\overline{\text{ACK}}$ the receive address or data byte, rather than the hardware. This functionality adds support for PMBus™ that was not present on previous versions of this module.

This list describes the steps that need to be taken by slave software to use these options for I^{2}C communication. Figure 15-16 displays a module using both address and data holding. Figure 15-17 includes the operation with the SEN bit of the SSPxCON2 register set.

1. S bit of SSPxSTAT is set; SSPxIF is set if interrupt on Start detect is enabled.
2. Matching address with R/$\overline{\text{W}}$ bit clear is clocked in. SSPxIF is set and CKP cleared after the 8th falling edge of SCLx.
3. Slave clears the SSPxIF.
4. Slave can look at the ACKTIM bit of the SSPxCON3 register to determine if the SSPxIF was after or before the $\overline{\text{ACK}}$.
5. Slave reads the address value from SSPxBUF, clearing the BF flag.
6. Slave sets $\overline{\text{ACK}}$ value clocked out to the master by setting ACKDT.
7. Slave releases the clock by setting CKP.
8. SSPxIF is set after an $\overline{\text{ACK}}$, not after a NACK.
9. If SEN = 1 the slave hardware will stretch the clock after the $\overline{\text{ACK}}$.
10. Slave clears SSPxIF

.

Note:	SSPxIF is still set after the 9th falling edge of SCLx even if there is no clock stretching and BF has been cleared. Only if NACK is sent to master is SSPxIF not set.

11. SSPxIF set and CKP cleared after 8th falling edge of SCLx for a received data byte.
12. Slave looks at ACKTIM bit of SSPxCON3 to determine the source of the interrupt.
13. Slave reads the received data from SSPxBUF clearing BF.
14. Steps 7-14 are the same for each received data byte.
15. Communication is ended by either the slave sending an $\overline{\text{ACK}}$ = 1, or the master sending a Stop condition. If a Stop is sent and Interrupt on Stop detect is disabled, the slave will only know by polling the P bit of the SSTSTAT register.

15.5.3.3 7-bit Transmission with Address Hold Enabled

Setting the AHEN bit of the SSPxCON3 register enables additional clock stretching and interrupt generation after the 8th falling edge of a received matching address. Once a matching address has been clocked in, CKP is cleared and the SSPxIF interrupt is set.

Figure 15-19 displays a standard waveform of a 7-bit Address Slave Transmission with AHEN enabled.

1. Bus starts Idle.
2. Master sends Start condition; the S bit of SSPxSTAT is set; SSPxIF is set if interrupt on Start detect is enabled.
3. Master sends matching address with R/$\overline{W}$ bit set. After the 8th falling edge of the SCLx line the CKP bit is cleared and SSPxIF interrupt is generated.
4. Slave software clears SSPxIF.
5. Slave software reads ACKTIM bit of SSPxCON3 register, and R/$\overline{W}$ and D/$\overline{A}$ of the SSPxSTAT register to determine the source of the interrupt.
6. Slave reads the address value from the SSPxBUF register clearing the BF bit.
7. Slave software decides from this information if it wishes to $\overline{ACK}$ or not $\overline{ACK}$ and sets ACKDT bit of the SSPxCON2 register accordingly.
8. Slave sets the CKP bit releasing SCLx.
9. Master clocks in the $\overline{ACK}$ value from the slave.
10. Slave hardware automatically clears the CKP bit and sets SSPxIF after the $\overline{ACK}$ if the R/$\overline{W}$ bit is set.
11. Slave software clears SSPxIF.
12. Slave loads value to transmit to the master into SSPxBUF setting the BF bit.

Note: SSPxBUF cannot be loaded until after the $\overline{ACK}$.

13. Slave sets CKP bit releasing the clock.
14. Master clocks out the data from the slave and sends an $\overline{ACK}$ value on the 9th SCLx pulse.
15. Slave hardware copies the $\overline{ACK}$ value into the ACKSTAT bit of the SSPxCON2 register.
16. Steps 10-15 are repeated for each byte transmitted to the master from the slave.
17. If the master sends a not $\overline{ACK}$ the slave releases the bus allowing the master to send a Stop and end the communication.

Note: Master must send a not $\overline{ACK}$ on the last byte to ensure that the slave releases the SCLx line to receive a Stop.

15.8 Register Definitions: MSSP Control

REGISTER 15-2: SSPxSTAT: SSPx STATUS REGISTER

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	$D/\overline{A}$	P	S	$R/\overline{W}$	UA	BF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **SMP:** SPI Data Input Sample bit

SPI Master mode:
1 = Input data sampled at end of data output time
0 = Input data sampled at middle of data output time

SPI Slave mode:
SMP must be cleared when SPI is used in Slave mode

In I²C Master or Slave mode:
1 = Slew rate control disabled for standard speed mode (100 kHz and 1 MHz)
0 = Slew rate control enabled for high speed mode (400 kHz)

bit 6 **CKE:** SPI Clock Edge Select bit (SPI mode only)

In SPI Master or Slave mode:
1 = Transmit occurs on transition from active to Idle clock state
0 = Transmit occurs on transition from Idle to active clock state

In I²C mode only:
1 = Enable input logic so that thresholds are compliant with SMbus specification
0 = Disable SMbus specific inputs

bit 5 **$D/\overline{A}$:** Data/$\overline{\text{Address}}$ bit (I²C mode only)
1 = Indicates that the last byte received or transmitted was data
0 = Indicates that the last byte received or transmitted was address

bit 4 **P:** Stop bit

(I²C mode only. This bit is cleared when the MSSPx module is disabled, SSPxEN is cleared.)
1 = Indicates that a Stop bit has been detected last (this bit is '0' on Reset)
0 = Stop bit was not detected last

bit 3 **S:** Start bit

(I²C mode only. This bit is cleared when the MSSPx module is disabled, SSPxEN is cleared.)
1 = Indicates that a Start bit has been detected last (this bit is '0' on Reset)
0 = Start bit was not detected last

bit 2 **$R/\overline{W}$:** Read/$\overline{\text{Write}}$ bit information (I²C mode only)

This bit holds the $R/\overline{W}$ bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit, or not $\overline{\text{ACK}}$ bit.

In I²C Slave mode:
1 = Read
0 = Write

In I²C Master mode:
1 = Transmit is in progress
0 = Transmit is not in progress
OR-ing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSPx is in Idle mode.

bit 1 **UA:** Update Address bit (10-bit I²C mode only)
1 = Indicates that the user needs to update the address in the SSPxADD register
0 = Address does not need to be updated

bit 0 **BF:** Buffer Full Status bit

Receive (SPI and I²C modes):
1 = Receive complete, SSPxBUF is full
0 = Receive not complete, SSPxBUF is empty

Transmit (I²C mode only):
1 = Data transmit in progress (does not include the $\overline{\text{ACK}}$ and Stop bits), SSPxBUF is full
0 = Data transmit complete (does not include the $\overline{\text{ACK}}$ and Stop bits), SSPxBUF is empty

17.1 ADC Configuration

When configuring and using the ADC the following functions must be considered:

- Port configuration
- Channel selection
- ADC voltage reference selection
- ADC conversion clock source
- Interrupt control
- Results formatting

17.1.1 PORT CONFIGURATION

The ANSELx and TRISx registers configure the A/D port pins. Any port pin needed as an analog input should have its corresponding ANSx bit set to disable the digital input buffer and TRISx bit set to disable the digital output driver. If the TRISx bit is cleared, the digital output level (V_{OH} or V_{OL}) will be converted.

The A/D operation is independent of the state of the ANSx bits and the TRIS bits.

> **Note 1:** When reading the PORT register, all pins with their corresponding ANSx bit set read as cleared (a low level). However, analog conversion of pins configured as digital inputs (ANSx bit cleared and TRISx bit set) will be accurately converted.
>
> **2:** Analog levels on any pin with the corresponding ANSx bit cleared may cause the digital input buffer to consume current out of the device's specification limits.
>
> **3:** The PBADEN bit in Configuration Register 3H configures PORTB pins to reset as analog or digital pins by controlling how the bits in ANSELB are reset.

17.1.2 CHANNEL SELECTION

The CHS bits of the ADCON0 register determine which channel is connected to the sample and hold circuit.

When changing channels, a delay is required before starting the next conversion. Refer to **Section 17.2 "ADC Operation"** for more information.

17.1.3 ADC VOLTAGE REFERENCE

The PVCFG<1:0> and NVCFG<1:0> bits of the ADCON1 register provide independent control of the positive and negative voltage references.

The positive voltage reference can be:

- V_{DD}
- the fixed voltage reference (FVR BUF2)
- an external voltage source (V_{REF+})

The negative voltage reference can be:

- V_{SS}
- an external voltage source (V_{REF-})

17.1.4 SELECTING AND CONFIGURING ACQUISITION TIME

The ADCON2 register allows the user to select an acquisition time that occurs each time the GO/$\overline{\text{DONE}}$ bit is set.

Acquisition time is set with the ACQT<2:0> bits of the ADCON2 register. Acquisition delays cover a range of 2 to 20 T_{AD}. When the GO/$\overline{\text{DONE}}$ bit is set, the A/D module continues to sample the input for the selected acquisition time, then automatically begins a conversion. Since the acquisition time is programmed, there is no need to wait for an acquisition time between selecting a channel and setting the GO/$\overline{\text{DONE}}$ bit.

Manual acquisition is selected when ACQT<2:0> = `000`. When the GO/$\overline{\text{DONE}}$ bit is set, sampling is stopped and a conversion begins. The user is responsible for ensuring the required acquisition time has passed between selecting the desired input channel and setting the GO/$\overline{\text{DONE}}$ bit. This option is also the default Reset state of the ACQT<2:0> bits and is compatible with devices that do not offer programmable acquisition times.

In either case, when the conversion is completed, the GO/$\overline{\text{DONE}}$ bit is cleared, the ADIF flag is set and the A/D begins sampling the currently selected channel again. When an acquisition time is programmed, there is no indication of when the acquisition time ends and the conversion begins.

REGISTER 17-3: ADCON2: A/D CONTROL REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADFM	—	ACQT<2:0>			ADCS<2:0>		
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **ADFM:** A/D Conversion Result Format Select bit
1 = Right justified
0 = Left justified

bit 6 **Unimplemented:** Read as ‘0’

bit 5-3 **ACQT<2:0>:** A/D Acquisition time select bits. Acquisition time is the duration that the A/D charge holding capacitor remains connected to A/D channel from the instant the GO/$\overline{\text{DONE}}$ bit is set until conversions begins.
000 = 0[(1)]
001 = 2 TAD
010 = 4 TAD
011 = 6 TAD
100 = 8 TAD
101 = 12 TAD
110 = 16 TAD
111 = 20 TAD

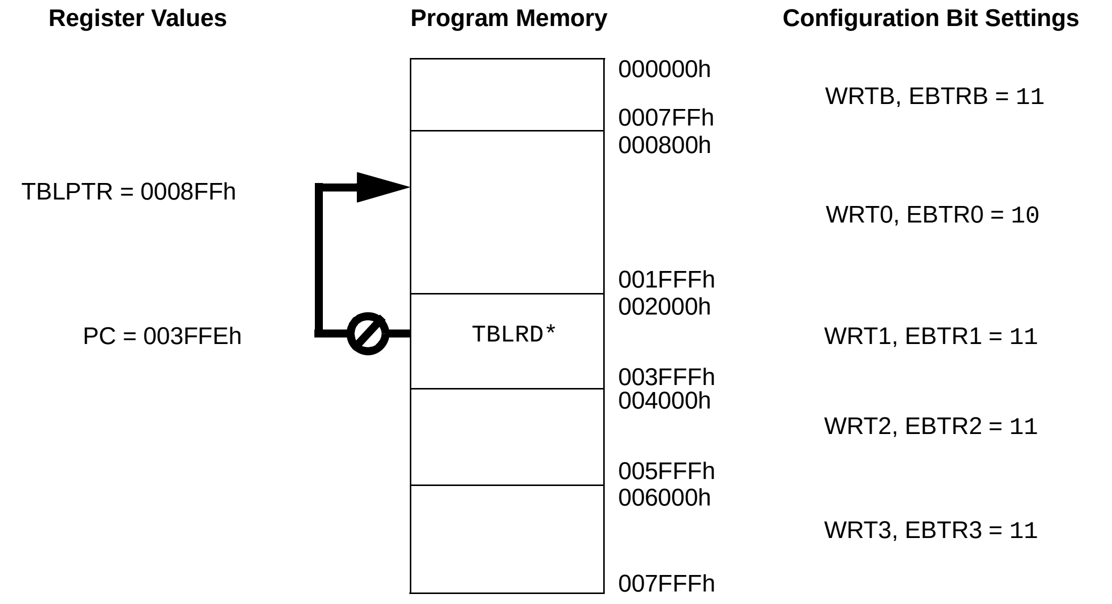
bit 2-0 **ADCS<2:0>:** A/D Conversion Clock Select bits
000 = FOSC/2
001 = FOSC/8
010 = FOSC/32
011 = FRC[(1)] (clock derived from a dedicated internal oscillator = 600 kHz nominal)
100 = FOSC/4
101 = FOSC/16
110 = FOSC/64
111 = FRC[(1)] (clock derived from a dedicated internal oscillator = 600 kHz nominal)

Note 1: When the A/D clock source is selected as FRC then the start of conversion is delayed by one instruction cycle after the GO/$\overline{\text{DONE}}$ bit is set to allow the SLEEP instruction to be executed.

EXAMPLE 19-3: CAPACITANCE CALIBRATION ROUTINE

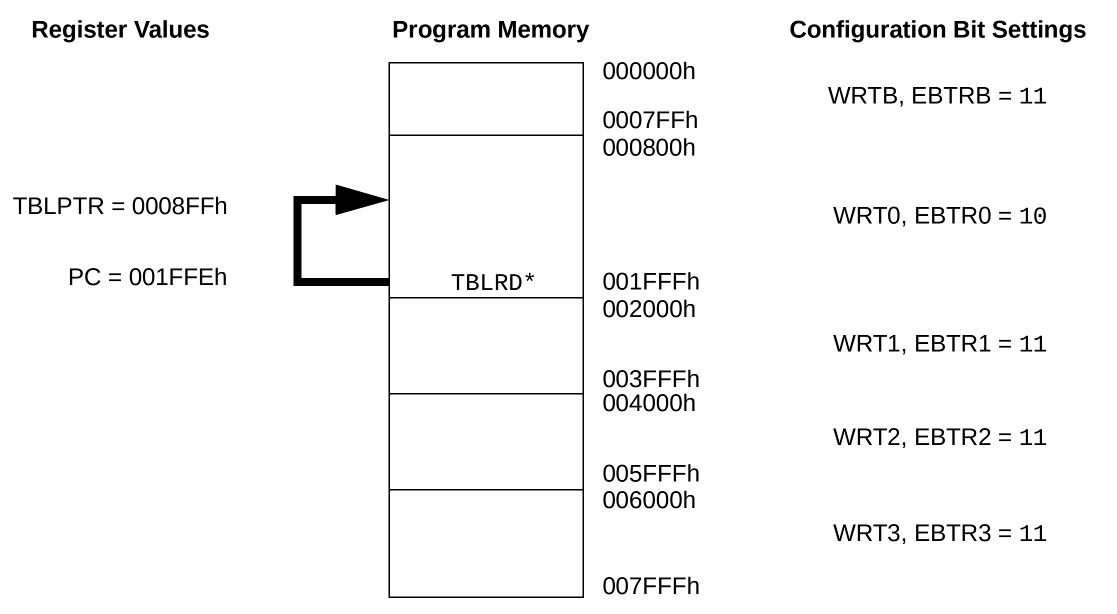
```
#include "p18cxxx.h"

#define COUNT 25                            //@ 8MHz INTFRC = 62.5 us.
#define ETIME COUNT*2.5                     //time in uS
#define DELAY for(i=0;i<COUNT;i++)
#define ADSCALE 1023                        //for unsigned conversion 10 sig
bits
#define ADREF 3.3                           //Vdd connected to A/D Vr+
#define RCAL .027                           //R value is 4200000 (4.2M)
                                            //scaled so that result is in
                                            //1/100th of uA

int main(void)
{
    int i;
    int j = 0;                              //index for loop
    unsigned int Vread = 0;
    float CTMUISrc, CTMUCap, Vavg, VTot, Vcal;

//assume CTMU and A/D have been set up correctly
//see Example 25-1 for CTMU & A/D setup
setup();

CTMUCONHbits.CTMUEN = 1;                    //Enable the CTMU
CTMUCONLbits.EDG1STAT = 0;                  // Set Edge status bits to zero
CTMUCONLbits.EDG2STAT = 0;
    for(j=0;j<10;j++)
    {
        CTMUCONHbits.IDISSEN = 1;           //drain charge on the circuit
        DELAY;                              //wait 125us
        CTMUCONHbits.IDISSEN = 0;           //end drain of circuit

        CTMUCONLbits.EDG1STAT = 1;          //Begin charging the circuit
                                            //using CTMU current source
        DELAY;                              //wait for 125us
        CTMUCONLbits.EDG1STAT = 0;          //Stop charging circuit

        PIR1bits.ADIF = 0;                  //make sure A/D Int not set
        ADCON0bits.GO=1;                    //and begin A/D conv.
        while(!PIR1bits.ADIF);              //Wait for A/D convert complete


        Vread = ADRES;                      //Get the value from the A/D
        PIR1bits.ADIF = 0;                  //Clear A/D Interrupt Flag
        VTot += Vread;                      //Add the reading to the total
    }

    Vavg = (float)(VTot/10.000);            //Average of 10 readings
    Vcal = (float)(Vavg/ADSCALE*ADREF);
    CTMUISrc = Vcal/RCAL;                   //CTMUISrc is in 1/100ths of uA
    CTMUCap = (CTMUISrc*ETIME/Vcal)/100;
}
```

FIGURE 24-4: EXTERNAL BLOCK TABLE READ (EBTRn) DISALLOWED



Results: All table reads from external blocks to Blockn are disabled whenever EBTRn = 0.
TABLAT register returns a value of '0'.

FIGURE 24-5: EXTERNAL BLOCK TABLE READ (EBTRn) ALLOWED



Results: Table reads permitted within Blockn, even when EBTRBn = 0.
TABLAT register returns the value of the data at the location TBLPTR.

26.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16, and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

26.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

26.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

26.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

27.9 Memory Programming Requirements

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ T_A ≤ +125°C				
Param No.	**Sym**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
		Internal Program Memory Programming Specifications(1)					
D170	V_{PP}	Voltage on $\overline{MCLR}$/V_{PP} pin	8	—	9	V	**(Note 3), (Note 4)**
D171	I_{DDP}	Supply Current during Programming	—	—	10	mA	
		Data EEPROM Memory					
D172	E_D	Byte Endurance	100K	—	—	E/W	-40°C to +85°C
D173	V_{DRW}	V_{DD} for Read/Write	V_{DDMIN}	—	V_{DDMAX}	V	Using EECON to read/ write
D175	T_{DEW}	Erase/Write Cycle Time	—	3	4	ms	
D176	T_{RETD}	Characteristic Retention	—	40	—	Year	Provided no other specifications are violated
D177	T_{REF}	Number of Total Erase/Write Cycles before Refresh(2)	1M	10M	—	E/W	-40°C to +85°C
		Program Flash Memory					
D178	E_P	Cell Endurance	10K	—	—	E/W	-40°C to +85°C **(Note 5)**
D179	V_{PR}	V_{DD} for Read	V_{DDMIN}	—	V_{DDMAX}	V	
D181	V_{IW}	V_{DD} for Row Erase or Write	2.2	—	V_{DDMAX}	V	PIC18LF24K22
D182	V_{IW}		V_{DDMIN}	—	V_{DDMAX}	V	PIC18(L)F26K22
D183	T_{IW}	Self-timed Write Cycle Time	—	2	—	ms	
D184	T_{RETD}	Characteristic Retention	—	40	—	Year	Provided no other specifications are violated

† Data in “Typ” column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: These specifications are for programming the on-chip program memory through the use of table write instructions.

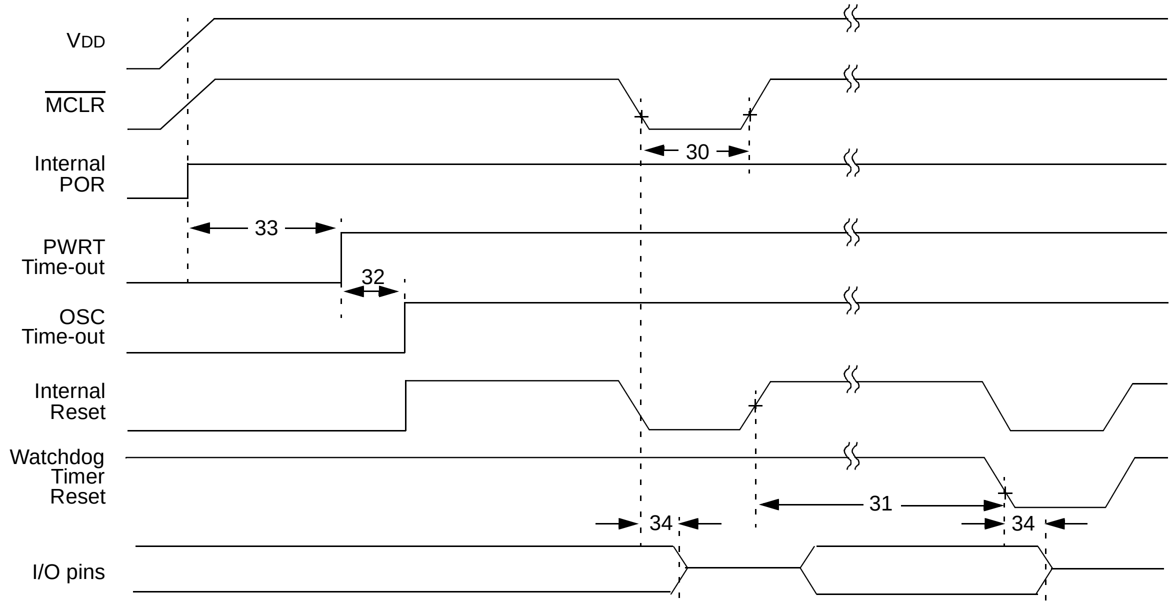
2: Refer to **Section 7.8 “Using the Data EEPROM”** for a more detailed discussion on data EEPROM endurance.

3: Required only if single-supply programming is disabled.

4: The MPLAB ICD 2 does not support variable V_{PP} output. Circuitry to limit the MPLAB ICD 2 V_{PP} voltage must be placed between the MPLAB ICD 2 and target system when programming or debugging with the MPLAB ICD 2.

5: Self-write and Block Erase.

FIGURE 27-9: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING



Note: Refer to Figure 27-6 for load conditions.

FIGURE 27-10: BROWN-OUT RESET TIMING

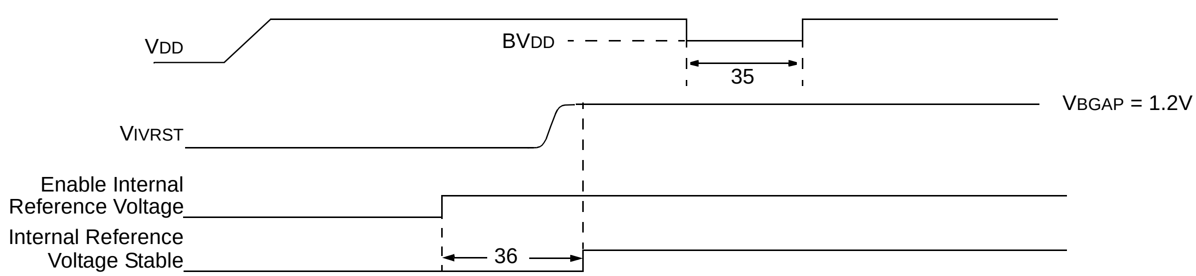


FIGURE 28-85: PIC18(L)F2X/4XK22 OUTPUT LOW VOLTAGE

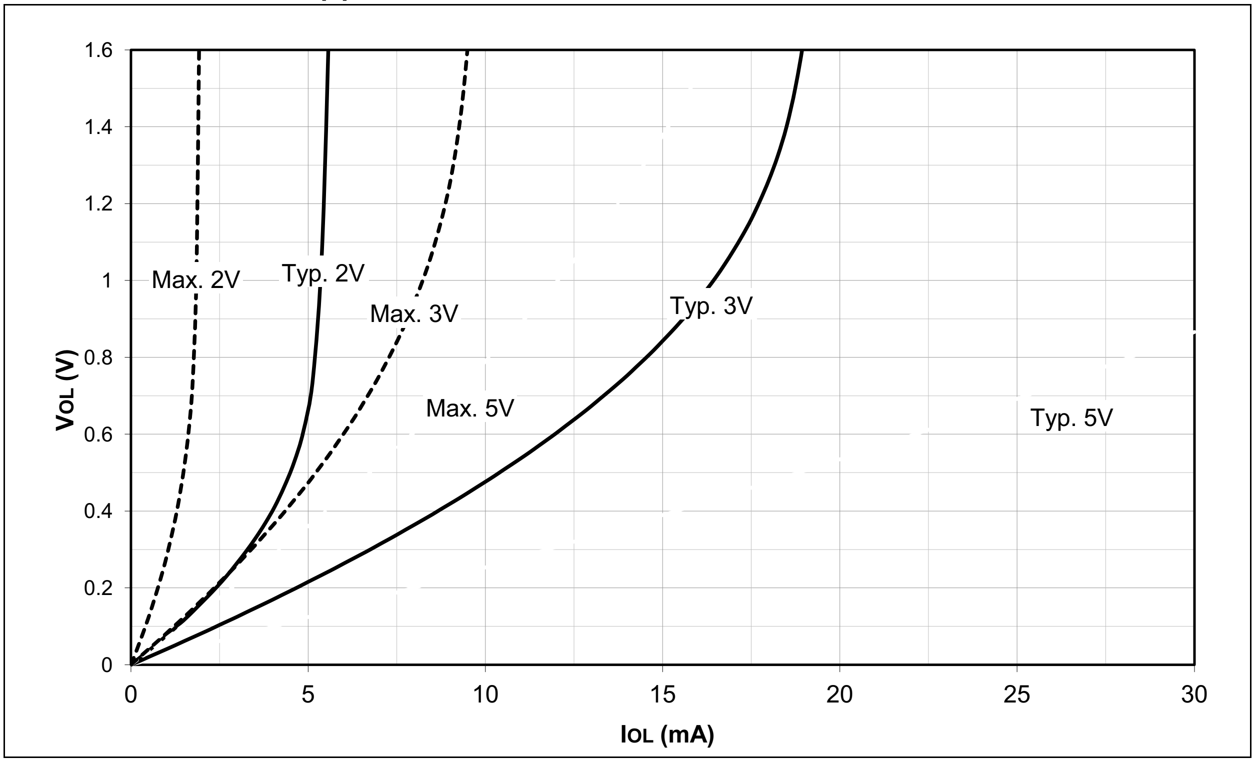


FIGURE 28-86: PIC18(L)F2X/4XK22 OUTPUT HIGH VOLTAGE

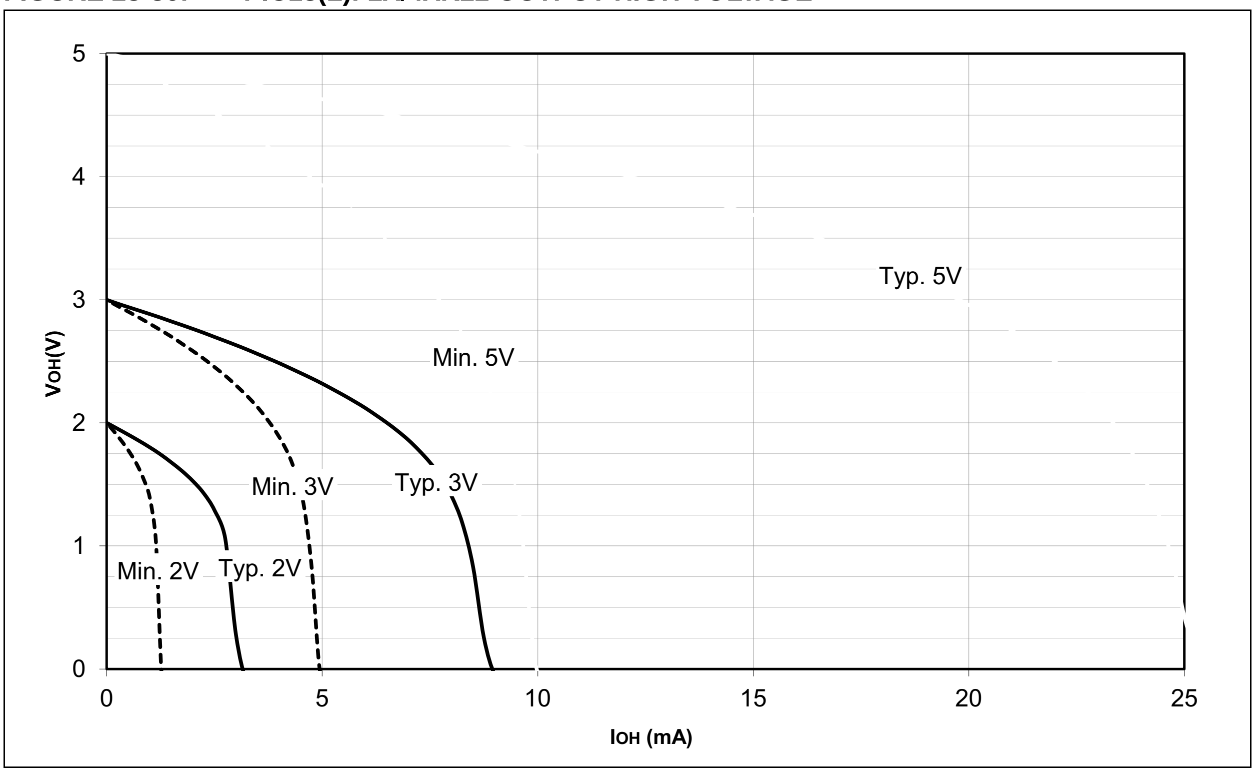
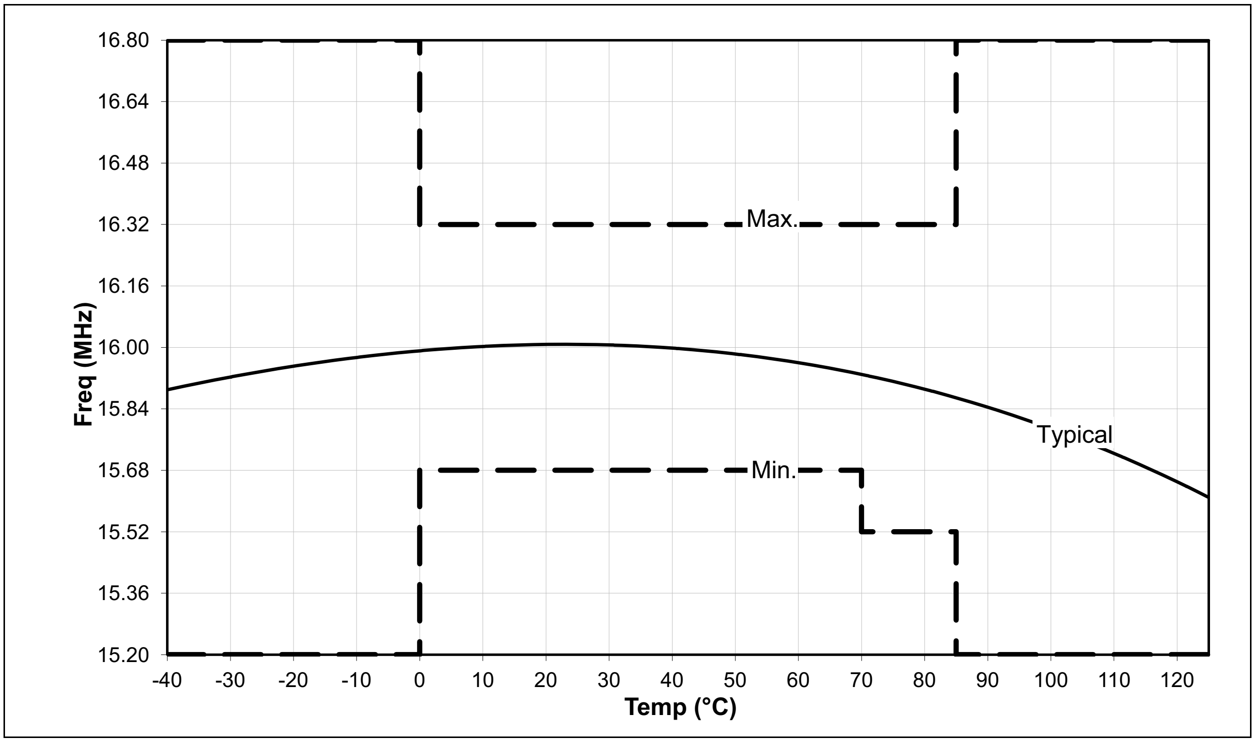


FIGURE 28-100: PIC18(L)F2X/4XK22 HF-INTOSC FREQUENCY vs. TEMPERATURE at 16 MHz
MIN / MAX: ± 2%, T = 0°C to +70°C
+2% / -3%, T = +70°C to +85°C
± 5%, T = -40°C to 0°C and +85°C to +125°C



APPENDIX B: DEVICE DIFFERENCES

The differences between the devices listed in this data sheet are shown in Table B-1.

TABLE B-1: DEVICE DIFFERENCES

Features[1]	PIC18F23K22 PIC18LF23K22	PIC18F24K22 PIC18LF24K22	PIC18F25K22 PIC18LF25K22	PIC18F26K22 PIC18LF26K22	PIC18F43K22 PIC18LF43K22	PIC18F44K22 PIC18LF44K22	PIC18F45K22 PIC18LF45K22	PIC18F46K22 PIC18LF46K22
Program Memory (Bytes)	8192	16384	32768	65536	8192	16384	32768	65536
SRAM (Bytes)	512	768	1536	3896	512	768	1536	3896
EEPROM (Bytes)	256	256	256	1024	256	256	256	1024
Interrupt Sources	26	26	33	33	26	26	33	33
I/O Ports	Ports A, B, C, (E)	Ports A, B, C, (E)	Ports A, B, C, (E)	Ports A, B, C, (E)	Ports A, B, C, D, E	Ports A, B, C, D, E	Ports A, B, C, D, E	Ports A, B, C, D, E
Capture/Compare/PWM Modules (CCP)	2	2	2	2	2	2	2	2
Enhanced CCP Modules (ECCP) Full Bridge	1	1	1	1	2	2	2	2
ECCP Module Half Bridge	2	2	2	2	1	1	1	1
10-bit Analog-to-Digital Module	17 input channels	17 input channels	17 input channels	17 input channels	28 input channels	28 input channels	28 input channels	28 input channels
Packages	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN 28-pin UQFN	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN 28-pin UQFN	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	40-pin PDIP 40-pin UQFN 44-pin TQFP 44-pin QFN	40-pin PDIP 40-pin UQFN 44-pin TQFP 44-pin QFN	40-pin PDIP 40-pin UQFN 44-pin TQFP 44-pin QFN	40-pin PDIP 40-pin UQFN 44-pin TQFP 44-pin QFN

Note 1: PIC18FXXK22: operating voltage, 2.3V-5.5V.
PIC18LFXXK22: operating voltage, 1.8V-3.6V.